



## Material Content Data Sheet



<b>Sales Product Name</b>		SAK-XC2764X-40F80LR AB		<b>Issued</b>		25. January 2018		
<b>MA#</b>		MA001689642						
<b>Package</b>		PG-LQFP-100-15		<b>Weight*</b>		744.17 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	28.688	3.86	3.86	38550	38550
leadframe	inorganic material	phosphorus	7723-14-0	0.067	0.01		90	
	non noble metal	zinc	7440-66-6	0.269	0.04		361	
	non noble metal	iron	7439-89-6	5.372	0.72		7219	
wire	non noble metal	copper	7440-50-8	218.131	29.31	30.08	293119	300789
	noble metal	palladium	7440-05-3	0.019	0.00		25	
	non noble metal	copper	7440-50-8	1.854	0.25	0.25	2492	2517
encapsulation	organic material	carbon black	1333-86-4	2.337	0.31		3140	
	plastics	epoxy resin	-	63.097	8.48		84788	
	inorganic material	silicondioxide	60676-86-0	401.950	54.01	62.80	540130	628058
leadfinish	noble metal	palladium	7440-05-3	0.002	0.00		2	
	noble metal	silver	7440-22-4	0.001	0.00		2	
	noble metal	gold	7440-57-5	0.003	0.00		4	
	non noble metal	nickel	7440-02-0	2.734	0.37	0.37	3674	3682
plating	noble metal	silver	7440-22-4	0.006	0.00		8	
	noble metal	palladium	7440-05-3	0.007	0.00		9	
	noble metal	gold	7440-57-5	0.011	0.00		15	
	non noble metal	nickel	7440-02-0	10.982	1.48	1.48	14757	14789
glue	plastics	epoxy resin	-	2.161	0.29		2904	
	noble metal	silver	7440-22-4	6.482	0.87	1.16	8711	11615
*deviation	< 10%				Sum in total:	100.00		1000000

### Important Remarks:

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